Data Sheet | October 1998 | File Number 1630.2

12A, 350V and 400V, 0.380 Ohm, N-Channel Power MOSFETs

These are N-Channel enhancement mode silicon gate power field effect transistors designed for applications such as switching regulators, switching converters, motor drivers, relay drivers and drivers for high-power bipolar switching transistors requiring high speed and low gate drive power. These types can be operated directly from integrated circuits.

Formerly developmental type TA17434.

Ordering Information

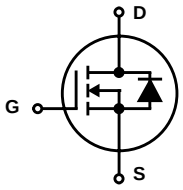
PART NUMBER	PACKAGE	BRAND
RFH12N35	TO-218AC	RFH12N35
RFH12N40	TO-218AC	RFH12N40

NOTE: When ordering, use the entire part number.

Features

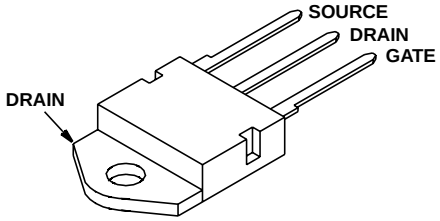
- 12A, 350V and 400V
- $r_{DS(ON)} = 0.380\Omega$
- Related Literature
  - TB334 “Guidelines for Soldering Surface Mount Components to PC Boards”

Symbol



Packaging

JEDEC TO-218AC



CAUTION: These devices are sensitive to electrostatic discharge; follow proper ESD Handling Procedures.
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Absolute Maximum Ratings $T_C = 25^oC$, Unless Otherwise Specified

		RFH12N35	RFH12N40	UNITS
Drain to Source Voltage (Note 1)	V_{DS}	350	400	V
Drain to Gate Voltage (R_{GS} = 20kΩ) (Note 1)	V_{DGR}	350	400	V
Continuous Drain Current	I_D	12	12	A
Pulsed Drain Current (Note 3)	I_{DM}	24	24	A
Gate to Source Voltage	V_{GS}	±20	±20	V
Maximum Power Dissipation	P_D	150	150	W
Linear Derating Factor		1.2	1.2	$W/^oC$
Operating and Storage Temperature	T_J, T_{STG}	-55 to 150	-55 to 150	^oC
Maximum Temperature for Soldering				
Leads at 0.063in (1.6mm) from Case for 10s	T_L	300	300	^oC
Package Body for 10s, See Techbrief 334	T_{pkg}	260	260	^oC

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

NOTE:

1. $T_J = 25^oC$ to 125^oC.

Electrical Specifications $T_C = 25^oC$, Unless Otherwise Specified

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Drain to Source Breakdown Voltage	BV_{DSS}	I_D = 250μA, V_{GS} = 0V				
RFH12N35			350	-	-	V
RFH12N40			400	-	-	V
Gate Threshold Voltage	$V_{GS(TH)}$	V_{GS} = V_{DS}, I_D = 250μA, (Figure 8)	2	-	4	V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = Rated BV_{DSS}, V_{GS} = 0V	-	-	1	μA
		V_{DS} = 0.8 x Rated BV_{DSS}, V_{GS} = 0V, $T_C = 125^oC$	-	-	25	μA
Gate to Source Leakage Current	I_{GSS}	V_{GS} = ±20V, V_{DS} = 0V	-	-	±100	nA
Drain to Source On Resistance (Note 2)	$r_{DS(ON)}$	I_D = 12A, V_{GS} = 10V, (Figures 6, 7)	-	-	0.380	Ω
Drain to Source On Voltage (Note 2)	$V_{DS(ON)}$	I_D = 12A, V_{GS} = 10V	-	-	4.56	V
Turn-On Delay Time	$t_{d(ON)}$	$I_D \approx$ 6A, V_{DD} = 200V, R_G = 50Ω, V_{GS} = 10V, R_L = 33Ω (Figures 10, 11, 12)	-	30	50	ns
Rise Time	t_r		-	105	150	ns
Turn-Off Delay Time	$t_{d(OFF)}$		-	480	750	ns
Fall Time	t_f		-	140	200	ns
Input Capacitance	C_{ISS}	V_{GS} = 0V, V_{DS} = 25V, f = 1MHz, (Figure 9)	-	-	3000	pF
Output Capacitance	C_{OSS}		-	-	900	pF
Reverse-Transfer Capacitance	C_{RSS}		-	-	400	pF
Thermal Resistance Junction-to-Case	$R_{\theta JC}$	RFH12N35, RFH12N40	-	-	0.83	$^oC/W$

Source to Drain Diode Specifications

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Source to Drain Diode Voltage (Note 2)	V_{SD}	I_{SD} = 6A	-	-	1.4	V
Diode Reverse Recovery Time	t_{rr}	I_{SD} = 4A, dI_{SD}/dt = 100A/μs	-	950	-	ns

NOTES:

2. Pulse test: pulse width ≤ 300μs, duty cycle ≤ 2%.
3. Repetitive rating: pulse width is limited by maximum junction temperature.

Typical Performance Curves Unless Otherwise Specified

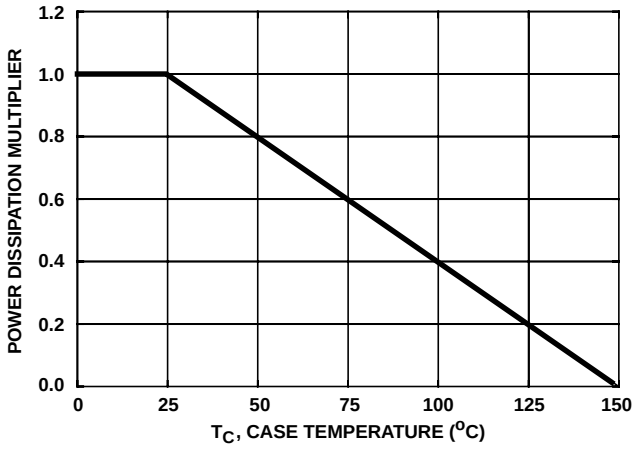


FIGURE 1. NORMALIZED POWER DISSIPATION vs CASE TEMPERATURE

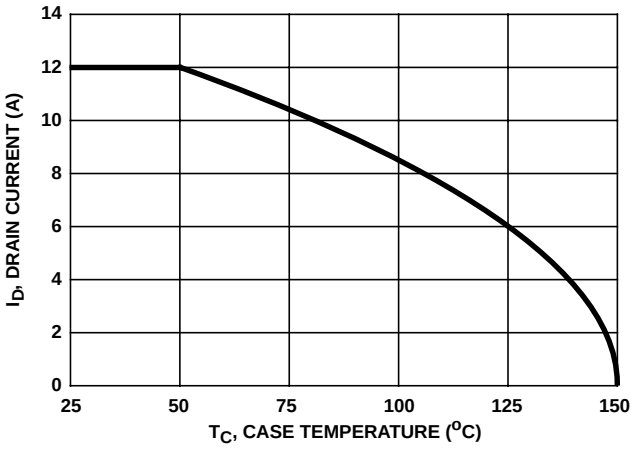


FIGURE 2. MAXIMUM CONTINUOUS DRAIN CURRENT vs CASE TEMPERATURE

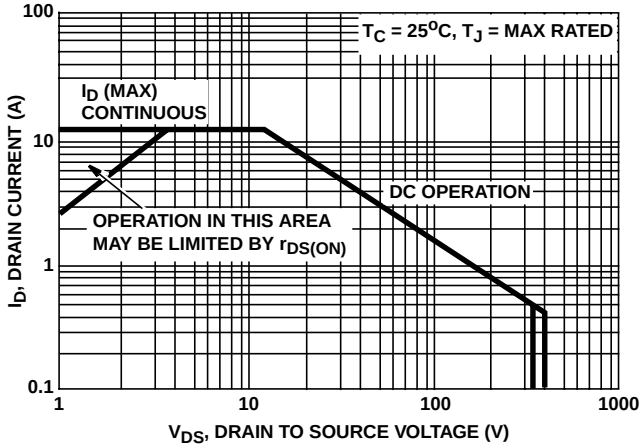


FIGURE 3. FORWARD BIAS SAFE OPERATING AREA

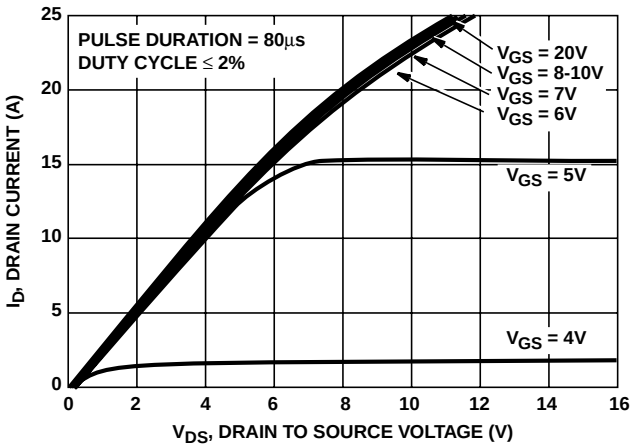


FIGURE 4. SATURATION CHARACTERISTICS

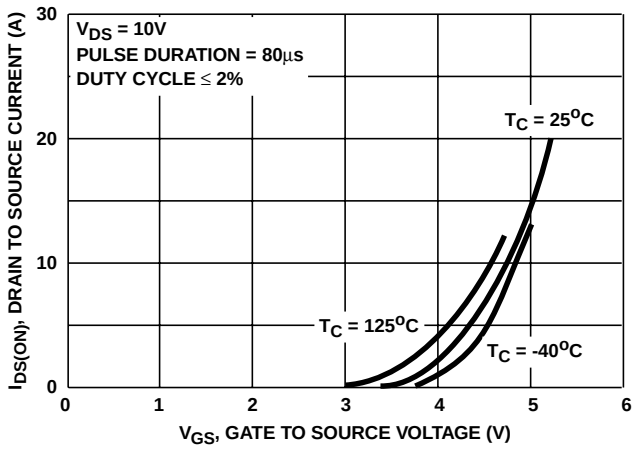


FIGURE 5. TRANSFER CHARACTERISTICS

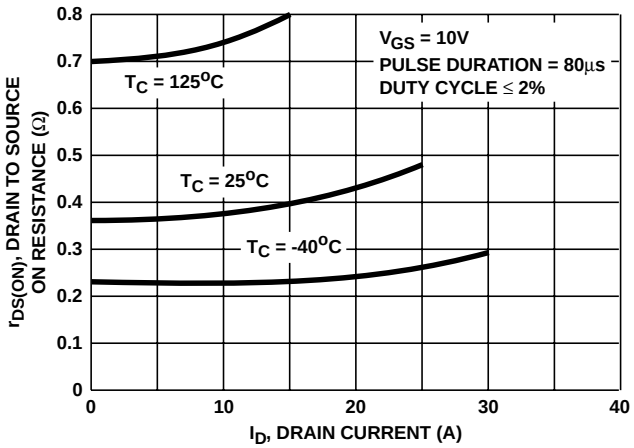


FIGURE 6. DRAIN TO SOURCE ON RESISTANCE vs GATE VOLTAGE AND DRAIN CURRENT

Typical Performance Curves Unless Otherwise Specified **(Continued)**

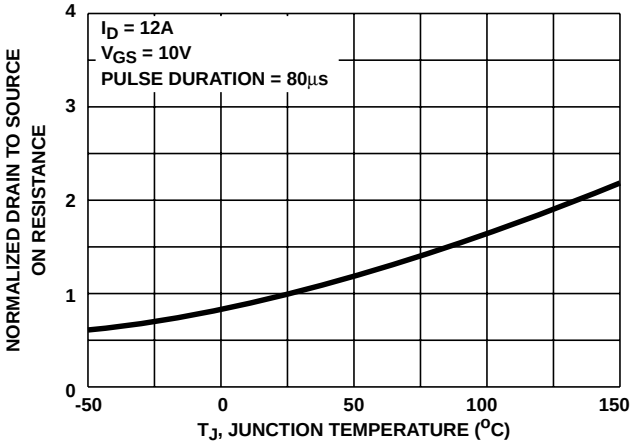


FIGURE 7. NORMALIZED DRAIN TO SOURCE ON RESISTANCE vs JUNCTION TEMPERATURE

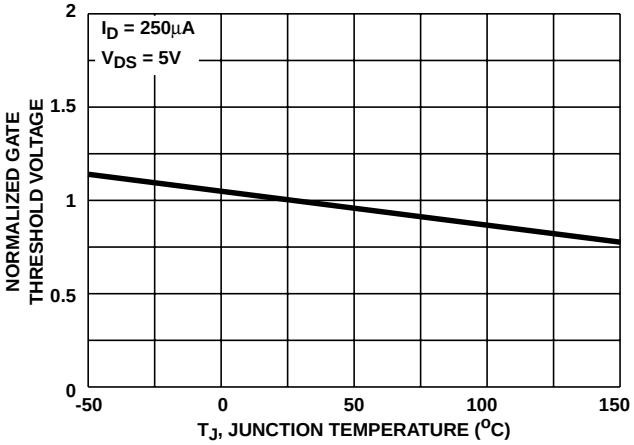


FIGURE 8. NORMALIZED GATE THRESHOLD VOLTAGE vs JUNCTION TEMPERATURE

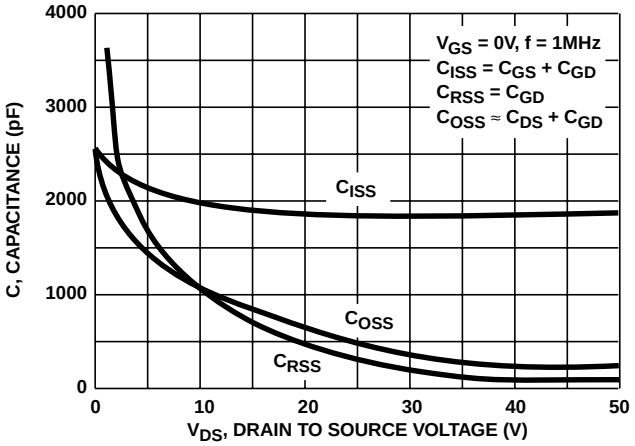
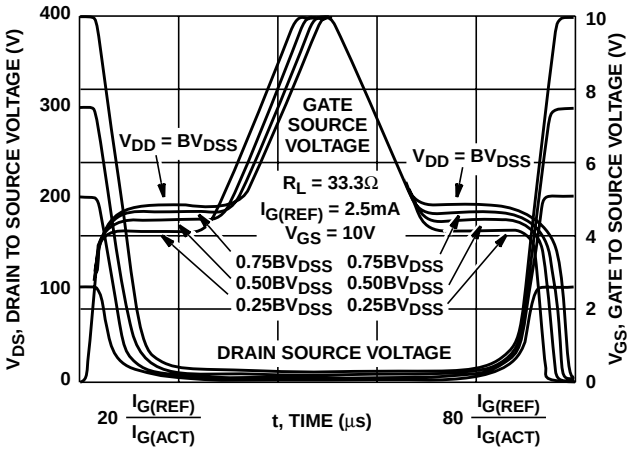


FIGURE 9. CAPACITANCE vs DRAIN TO SOURCE VOLTAGE



NOTE: Refer to Intersil Application Notes AN7254 and AN7260.

FIGURE 10. NORMALIZED SWITCHING WAVEFORMS FOR CONSTANT GATE CURRENT

Test Circuits and Waveforms

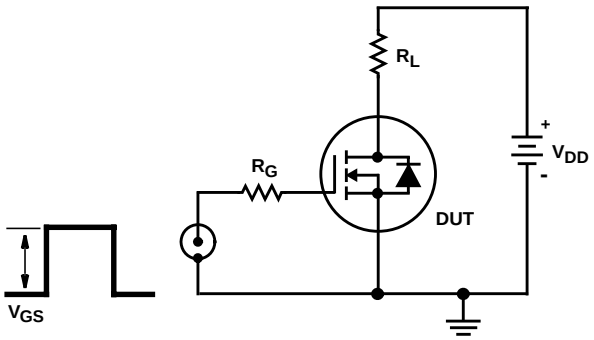


FIGURE 11. SWITCHING TIME TEST CIRCUIT

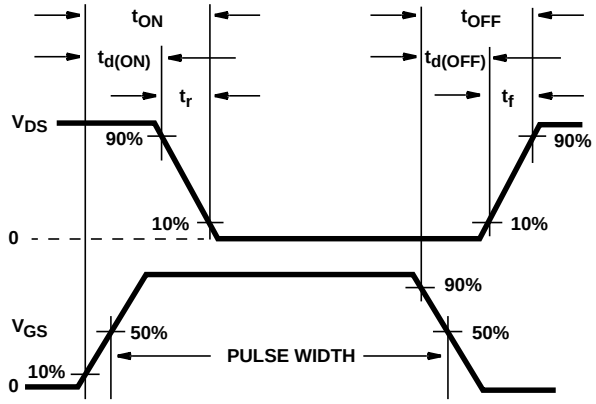


FIGURE 12. RESISTIVE SWITCHING WAVEFORMS

Test Circuits and Waveforms (Continued)

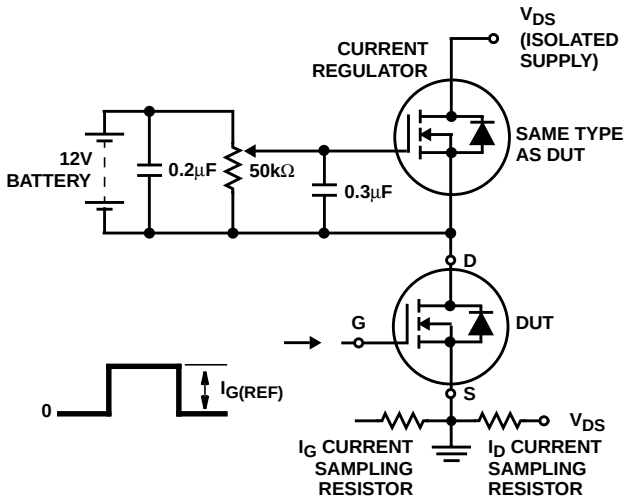


FIGURE 13. GATE CHARGE TEST CIRCUIT

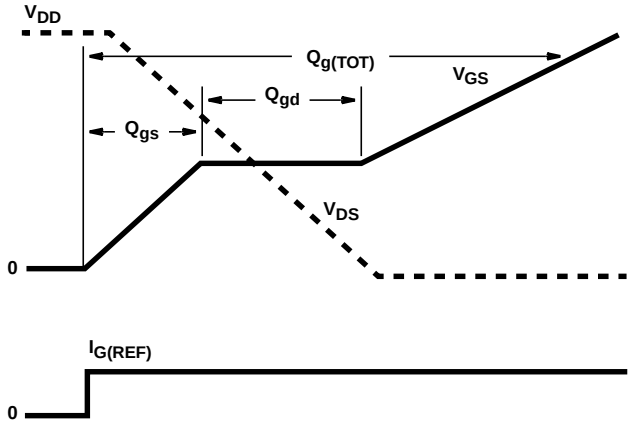


FIGURE 14. GATE CHARGE WAVEFORMS

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